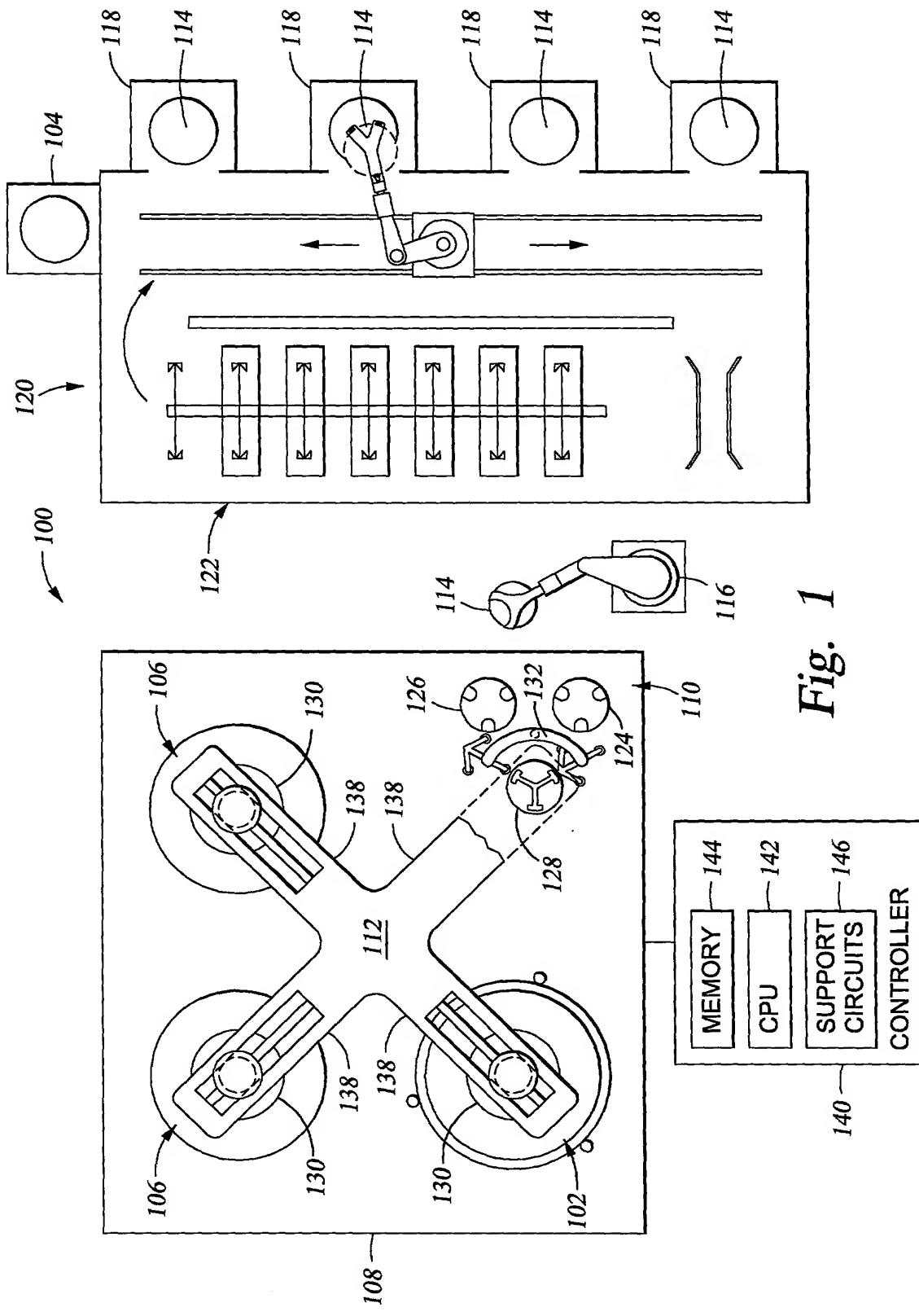


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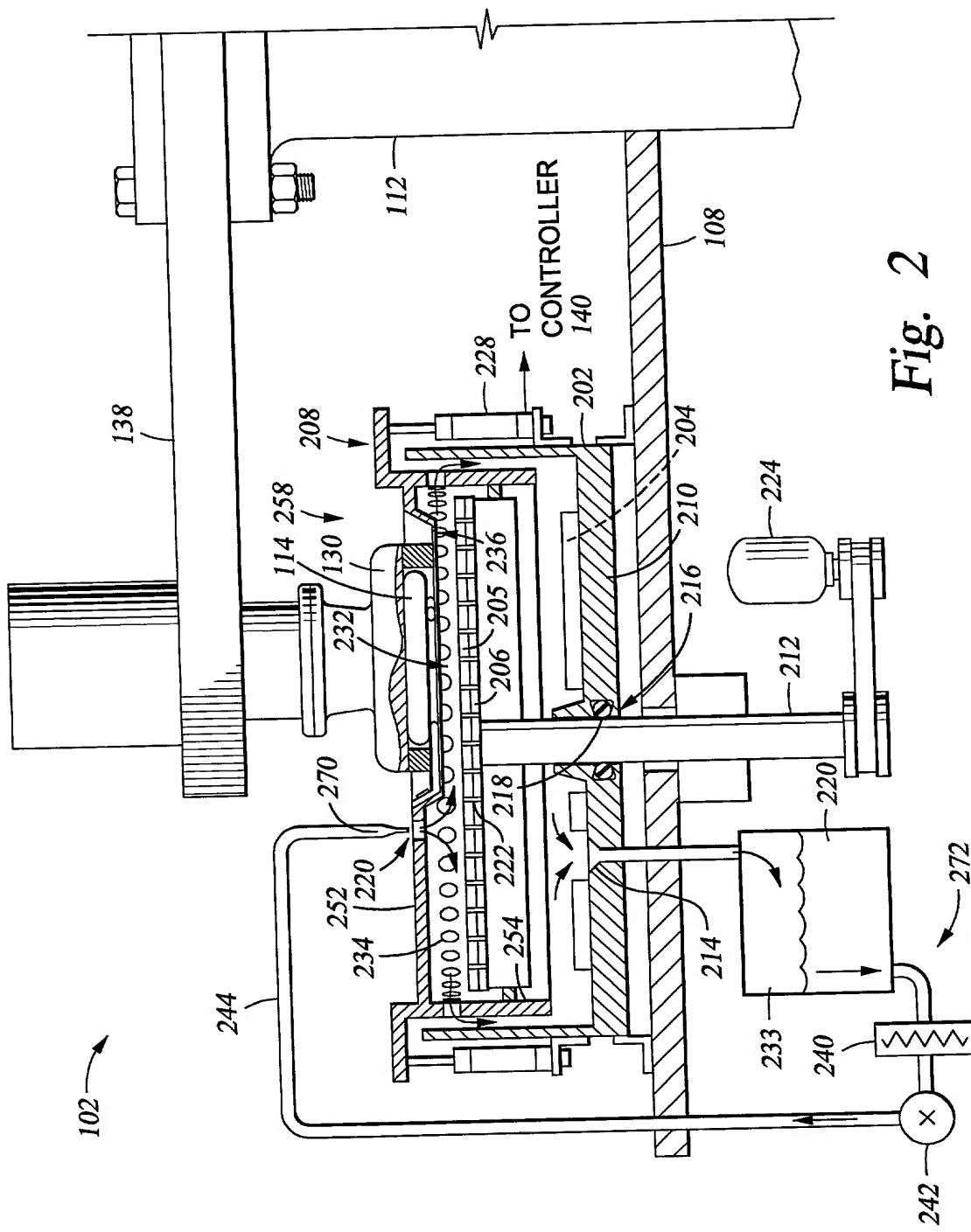
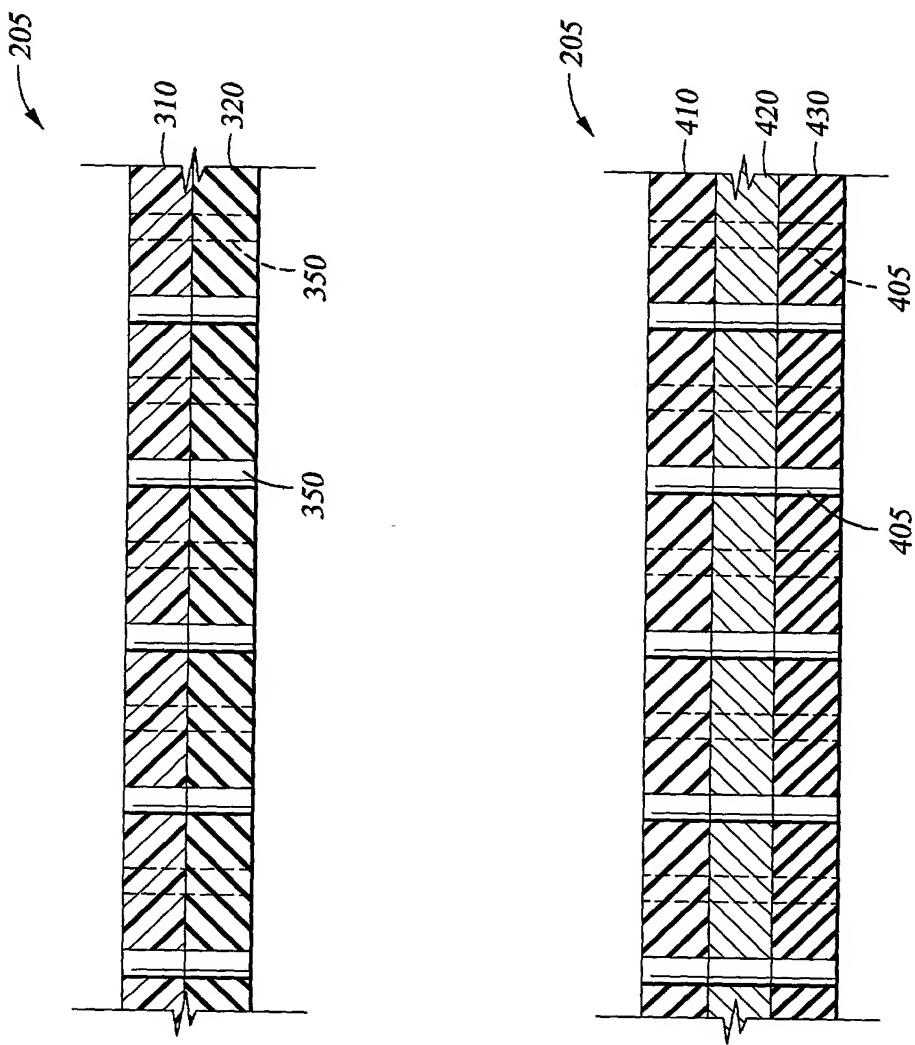


Fig. 2

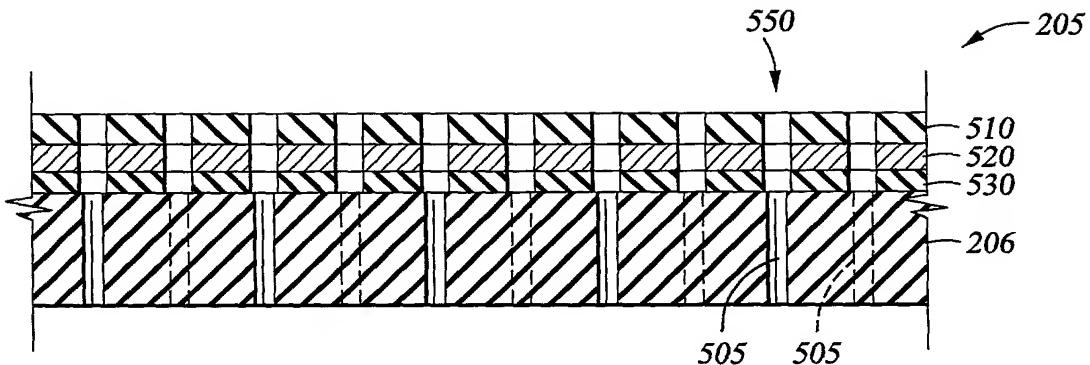
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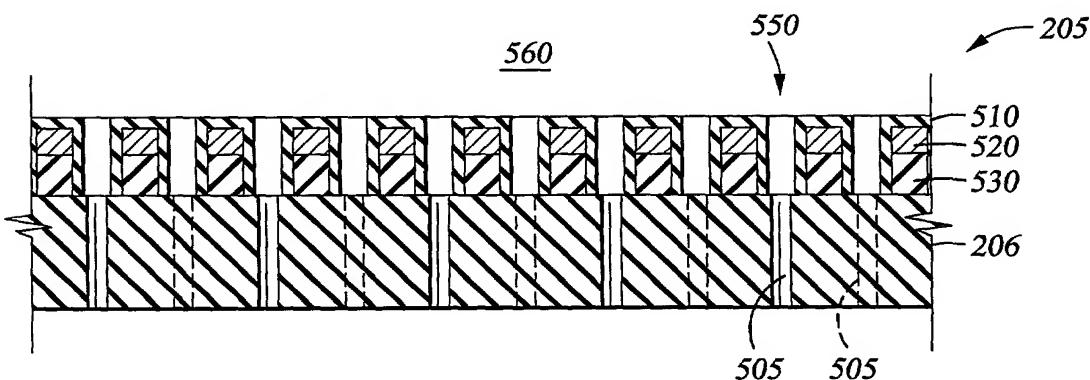
*Fig. 3*

*Fig. 4*

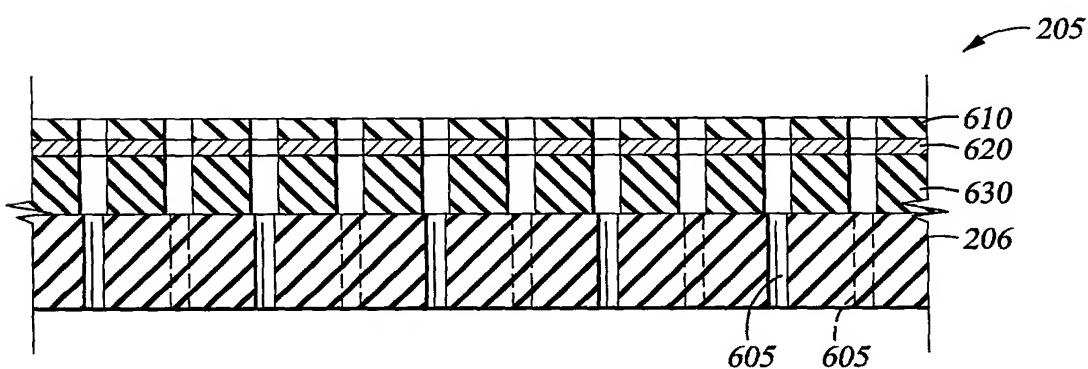
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*Fig. 5A*



*Fig. 5B*



*Fig. 6*

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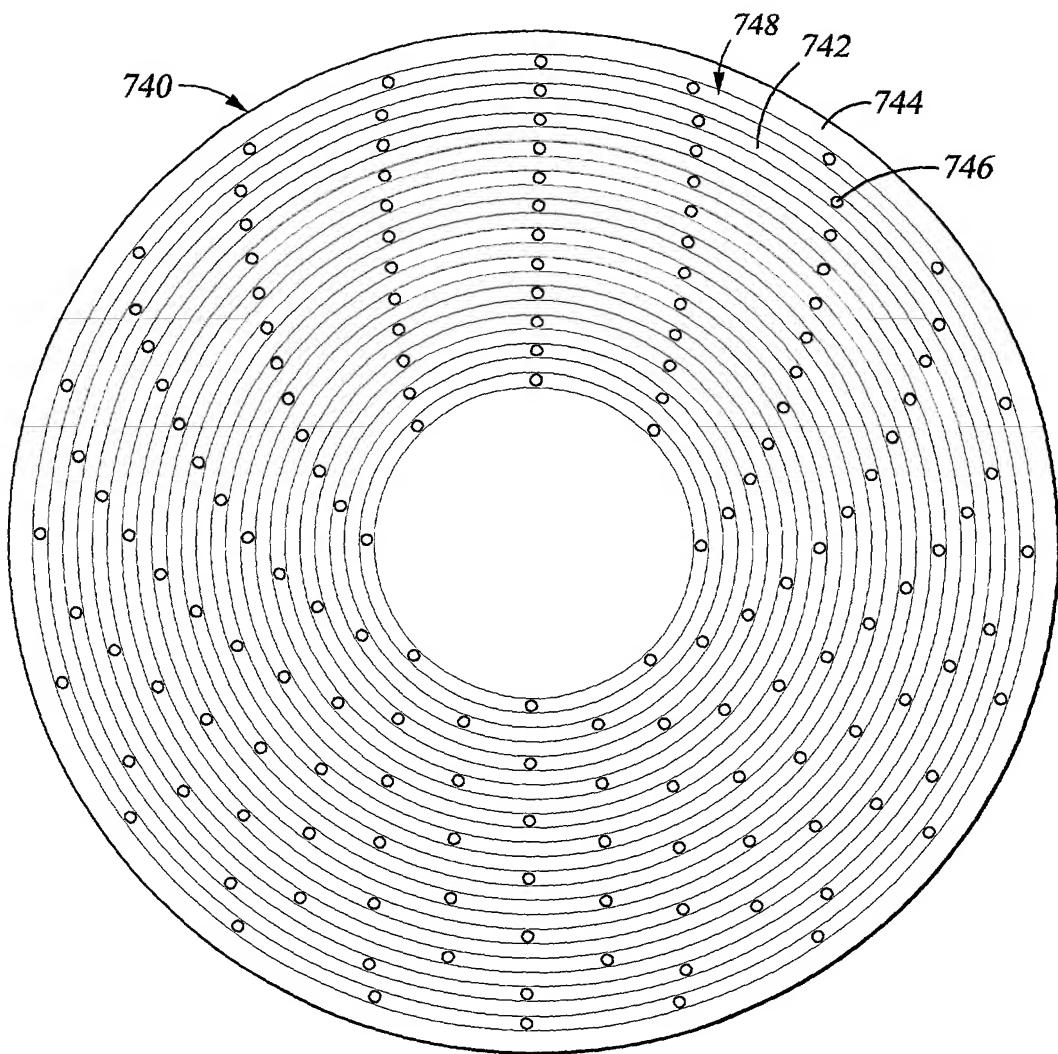
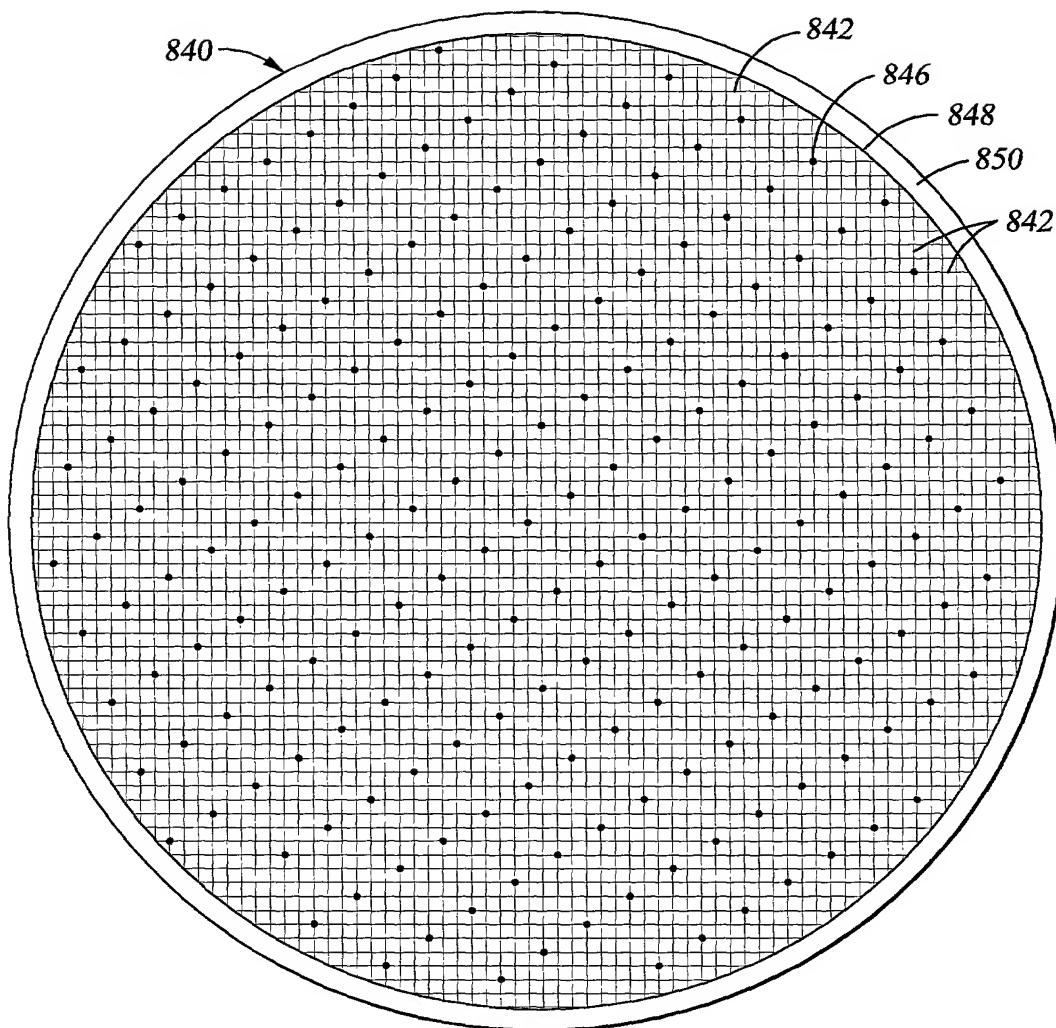


Fig. 7

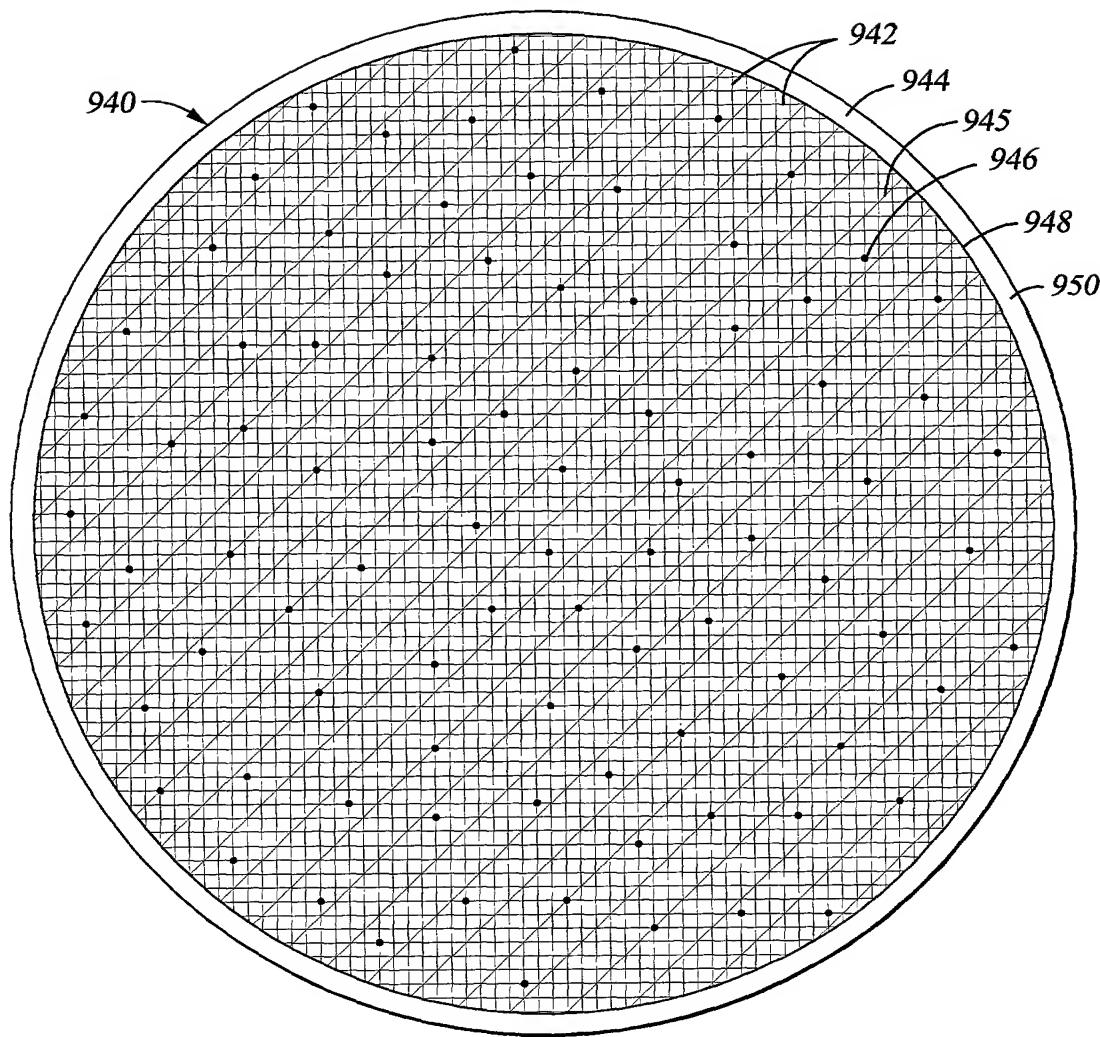
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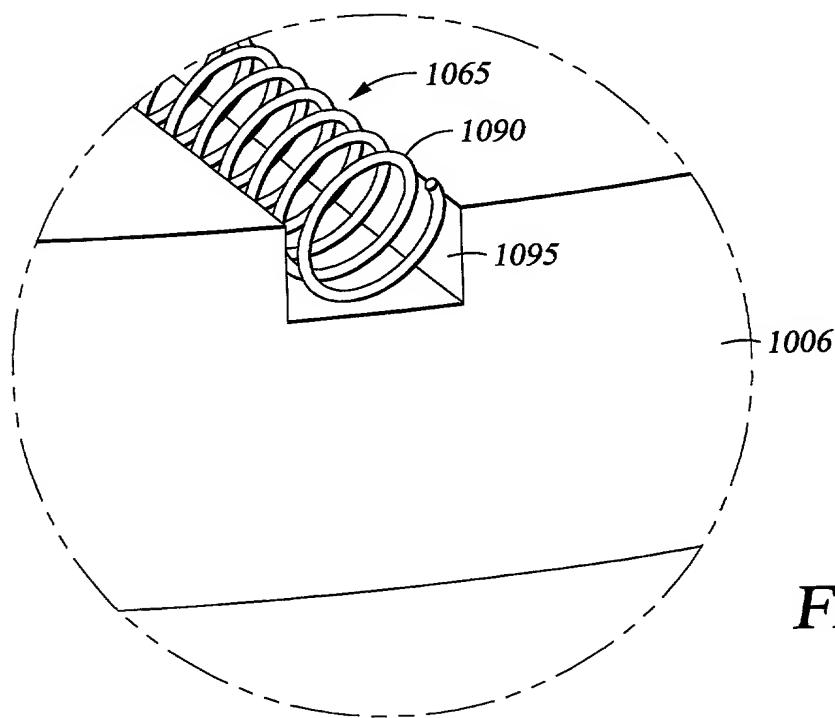
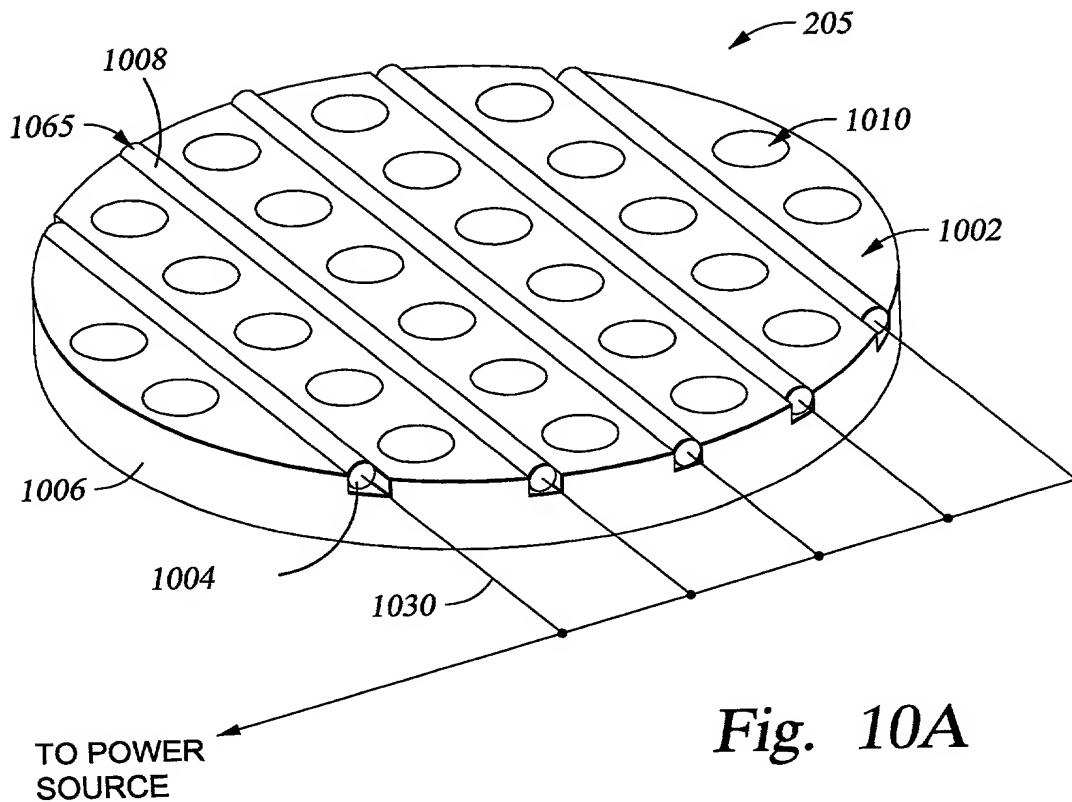
*Fig. 8*

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*Fig. 9*

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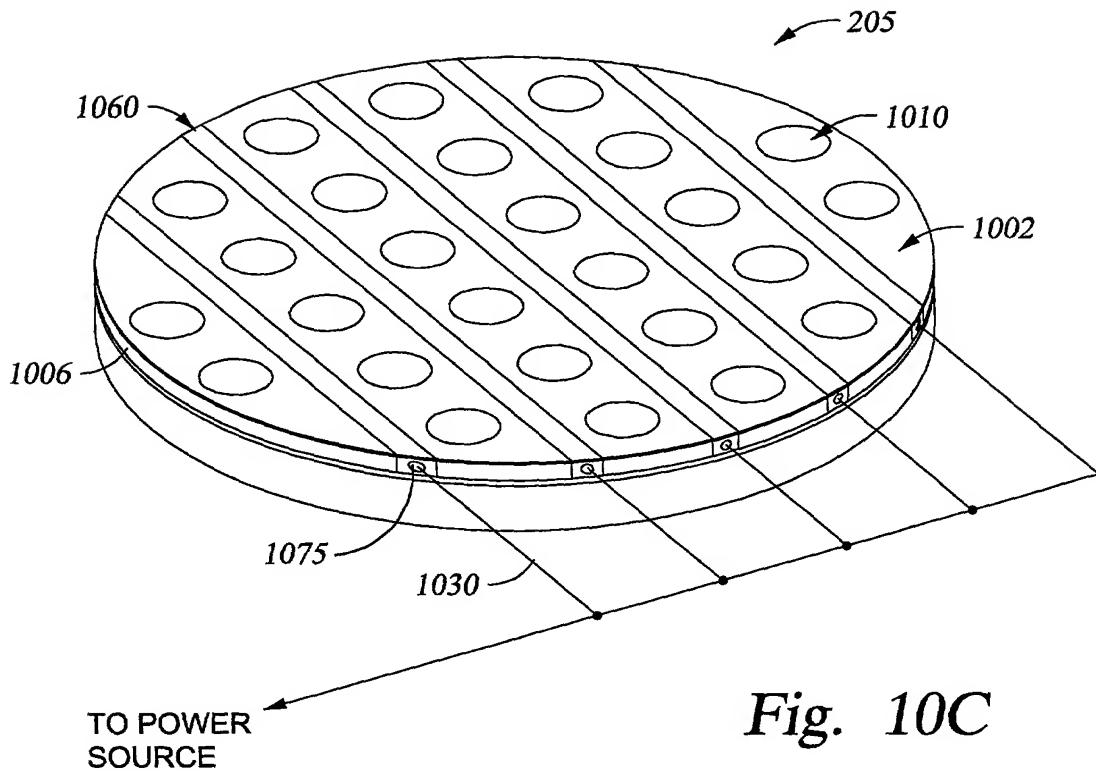


Fig. 10C

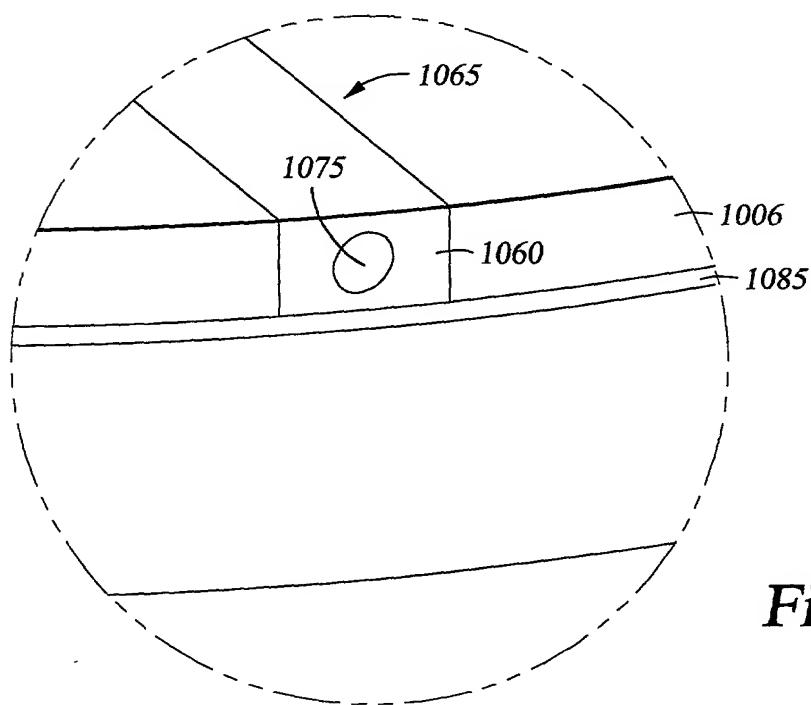


Fig. 10D

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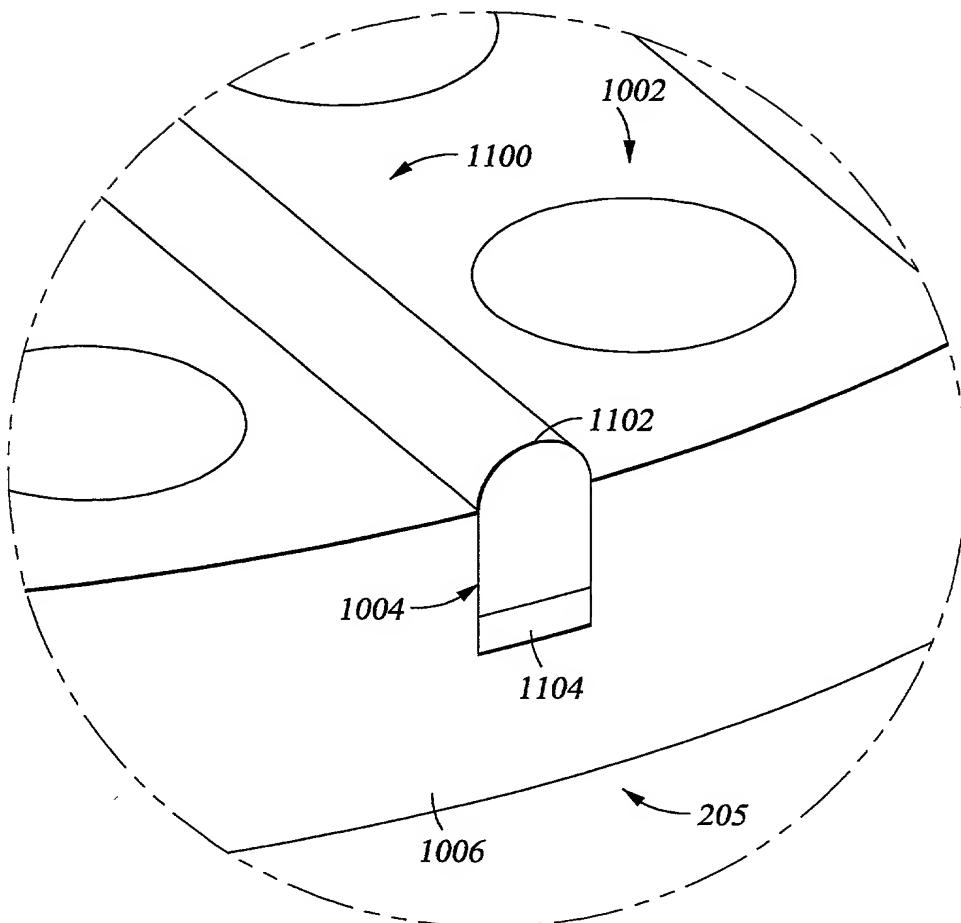


Fig. 11A

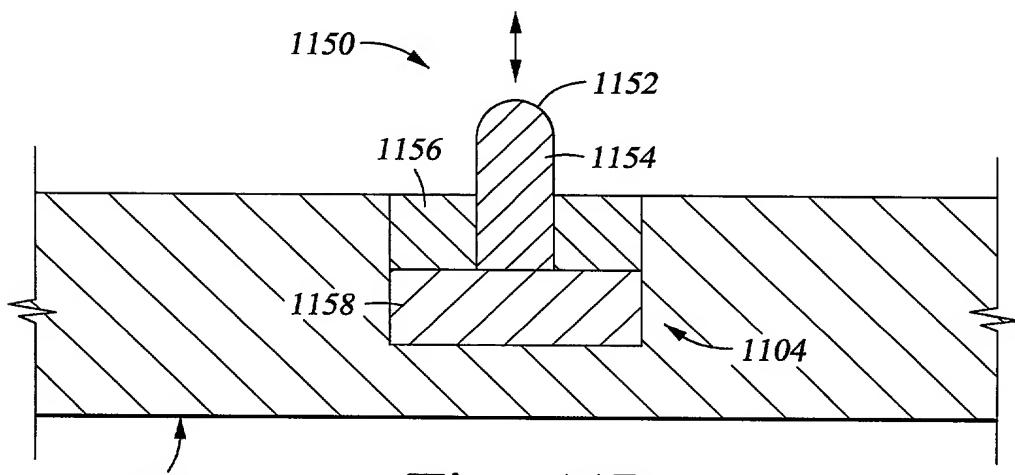
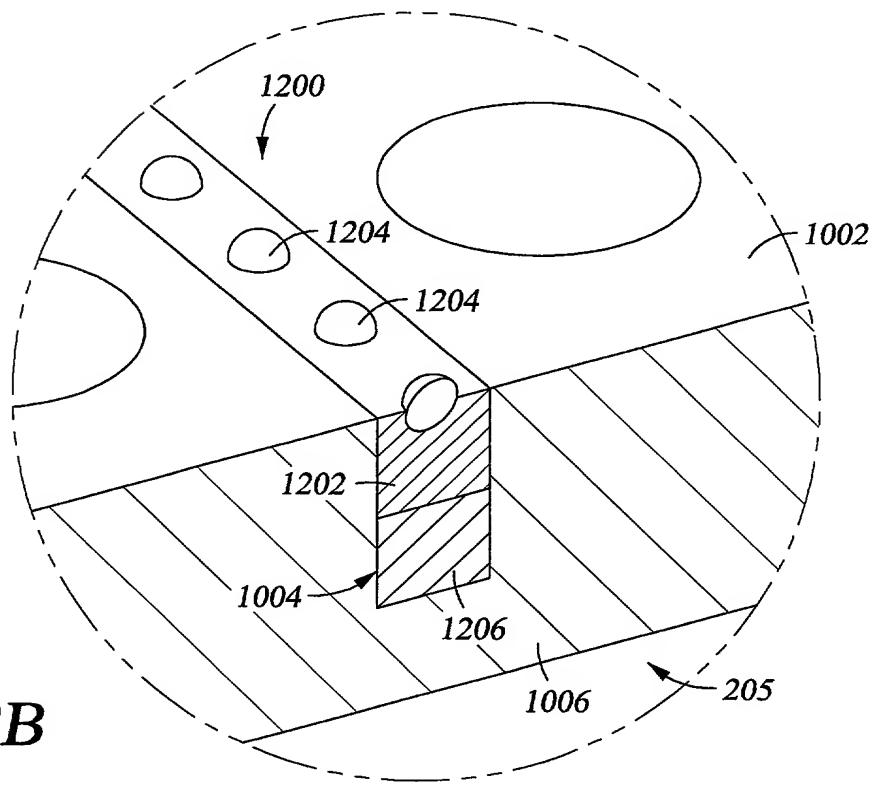
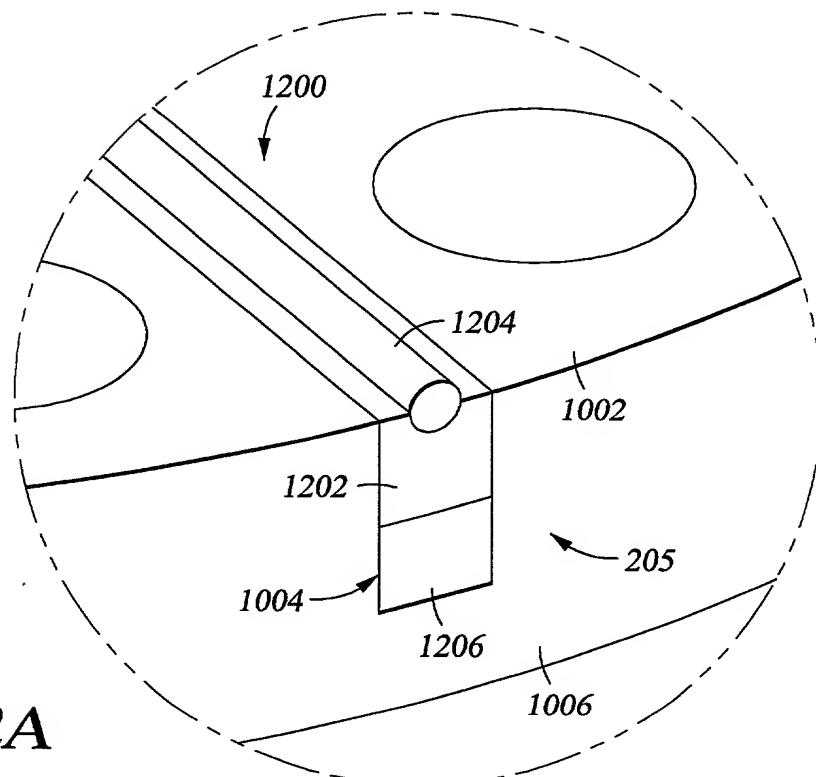


Fig. 11B

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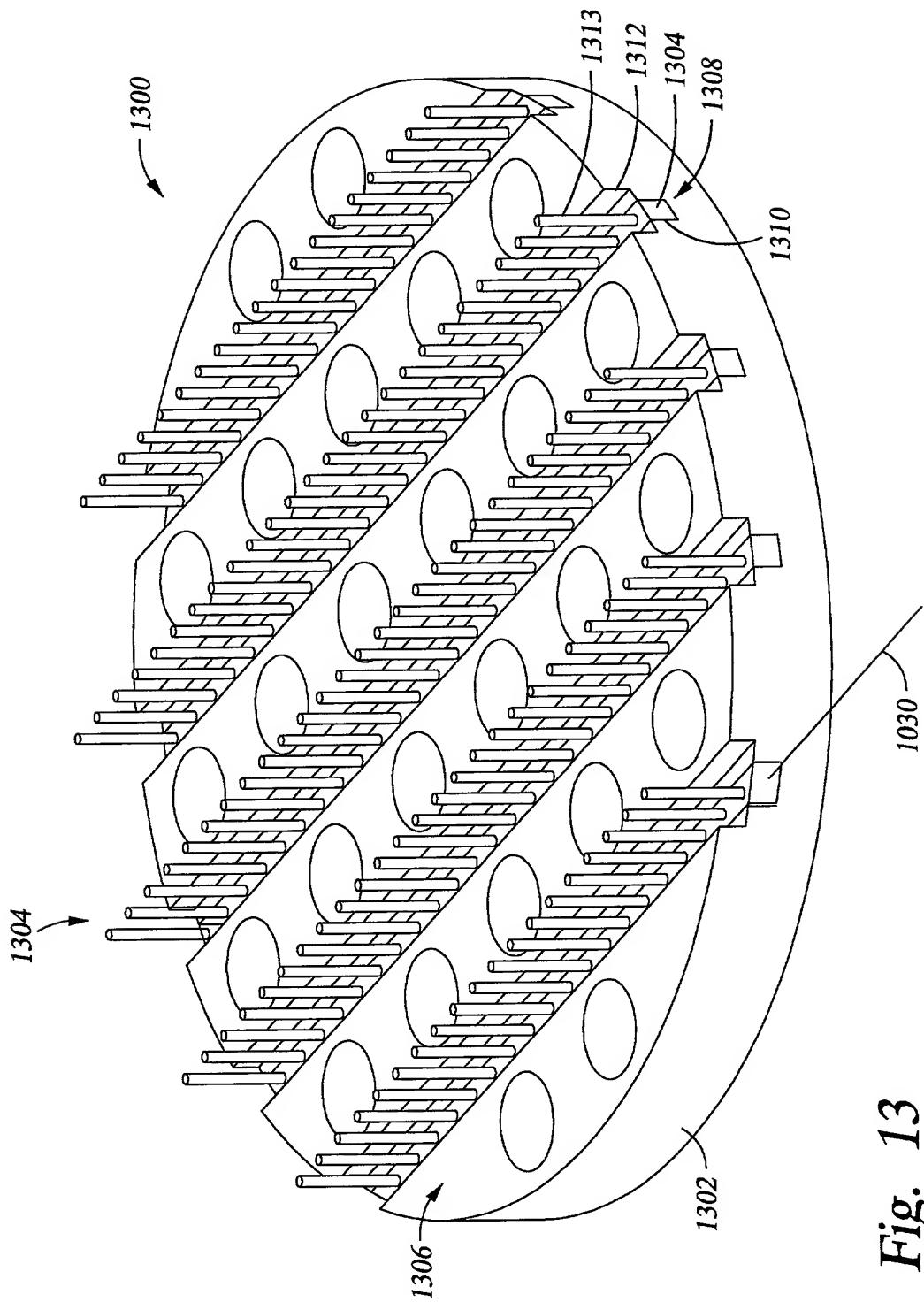


Fig. 13

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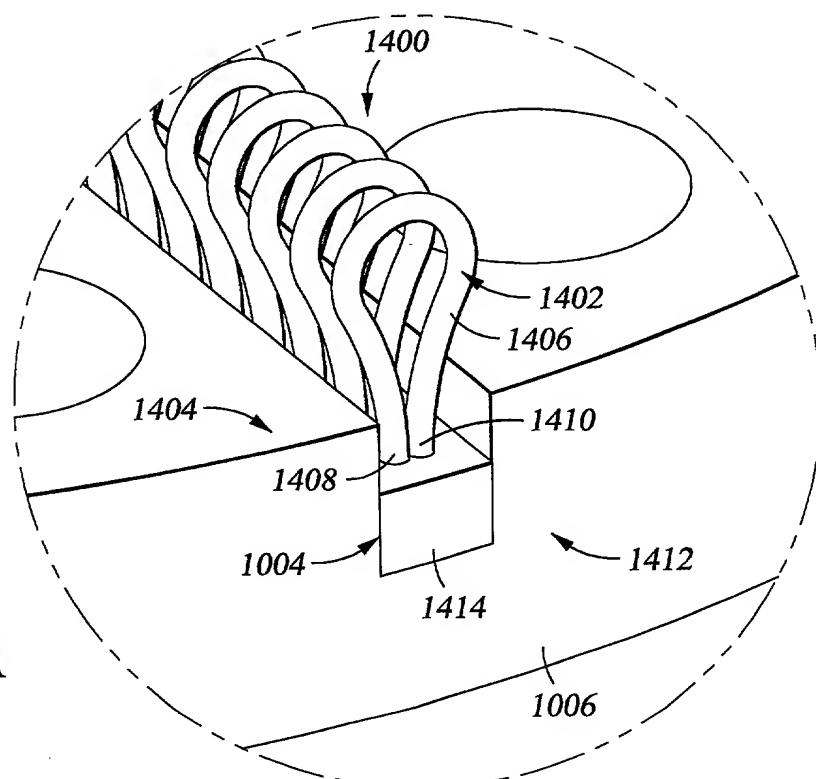


Fig. 14A

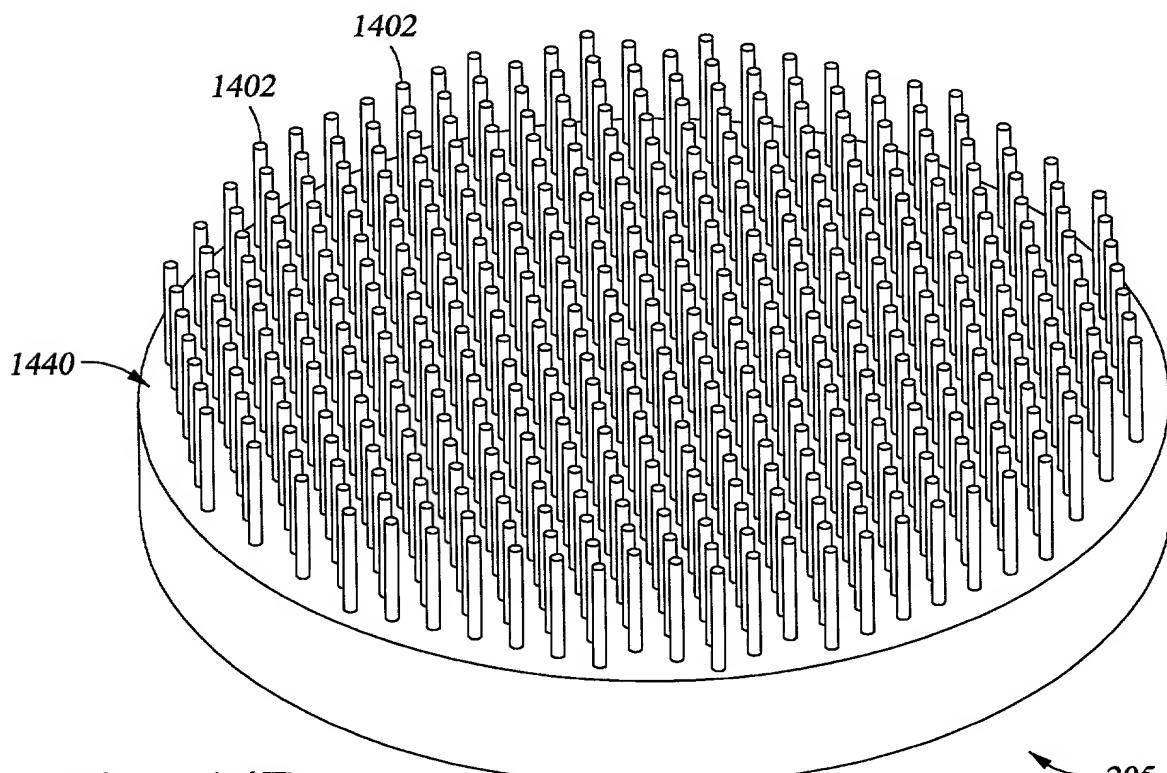


Fig. 14B

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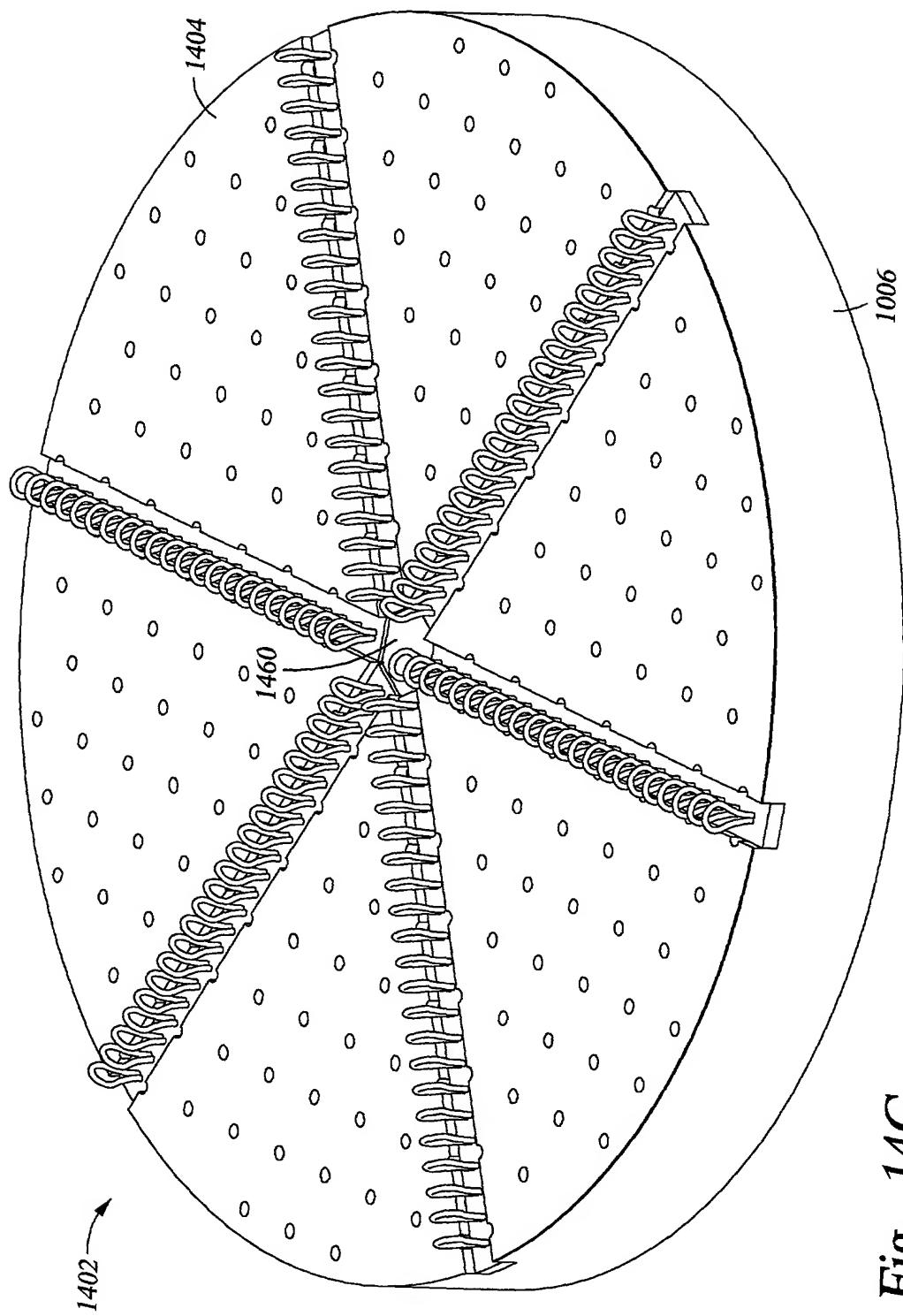


Fig. 14C

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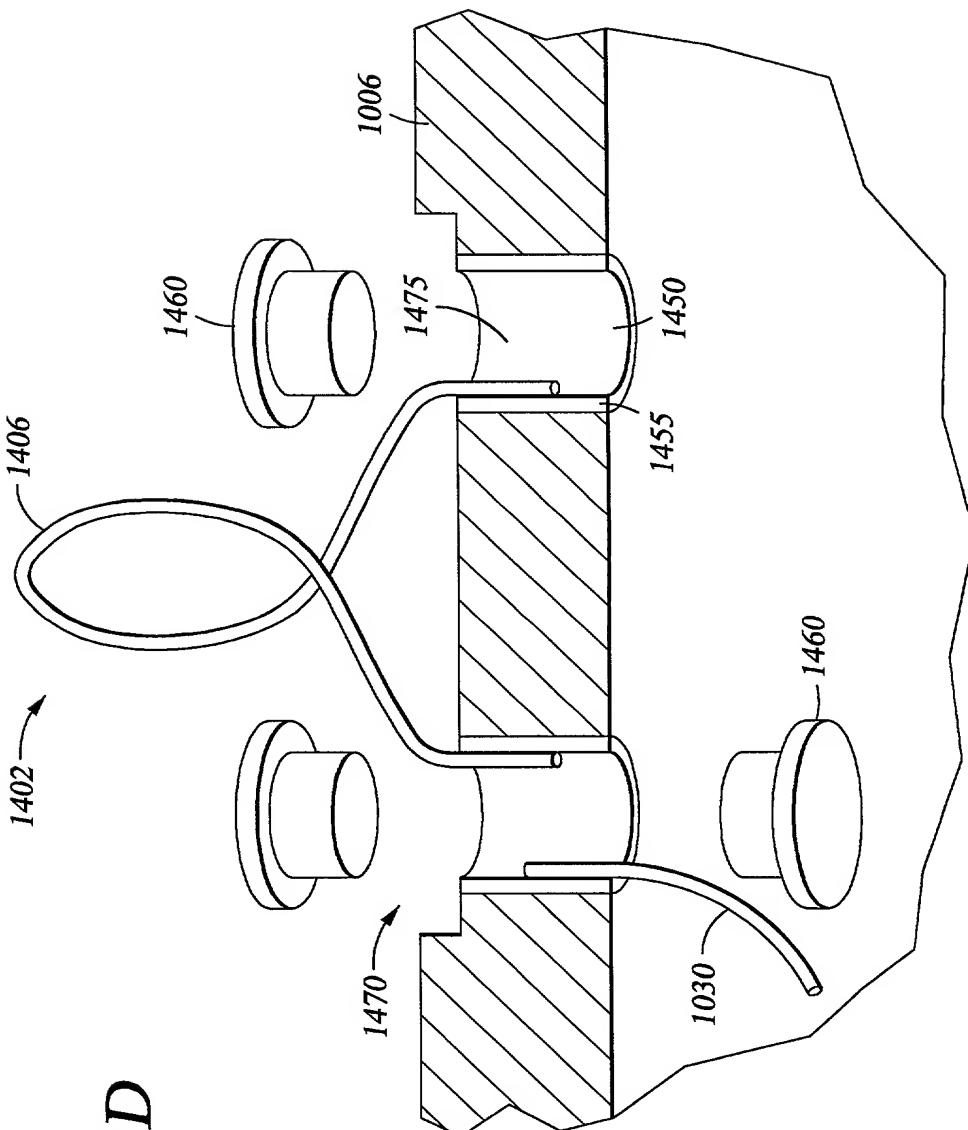


Fig. 14D

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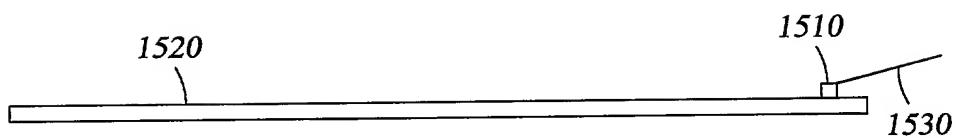


Fig. 15A

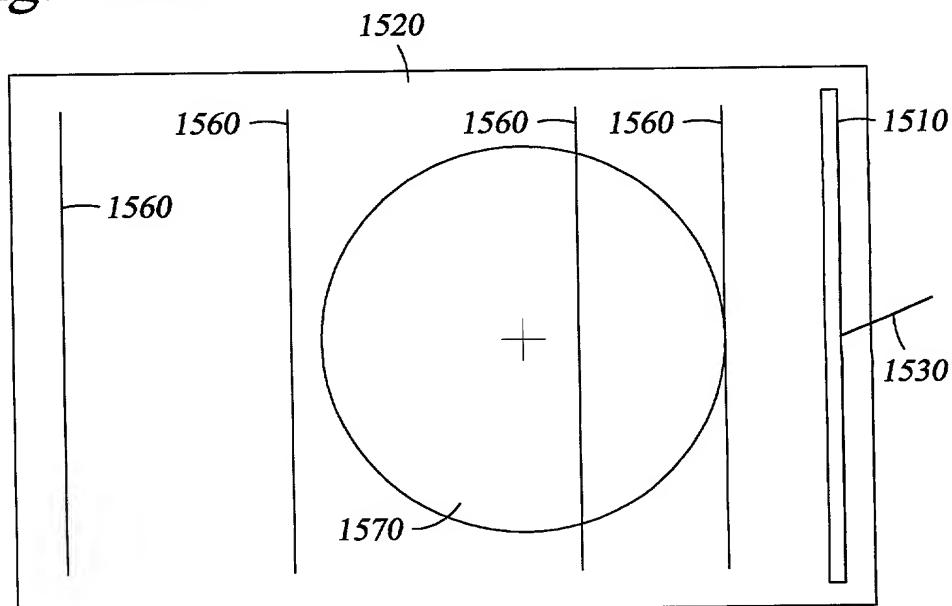


Fig. 15B

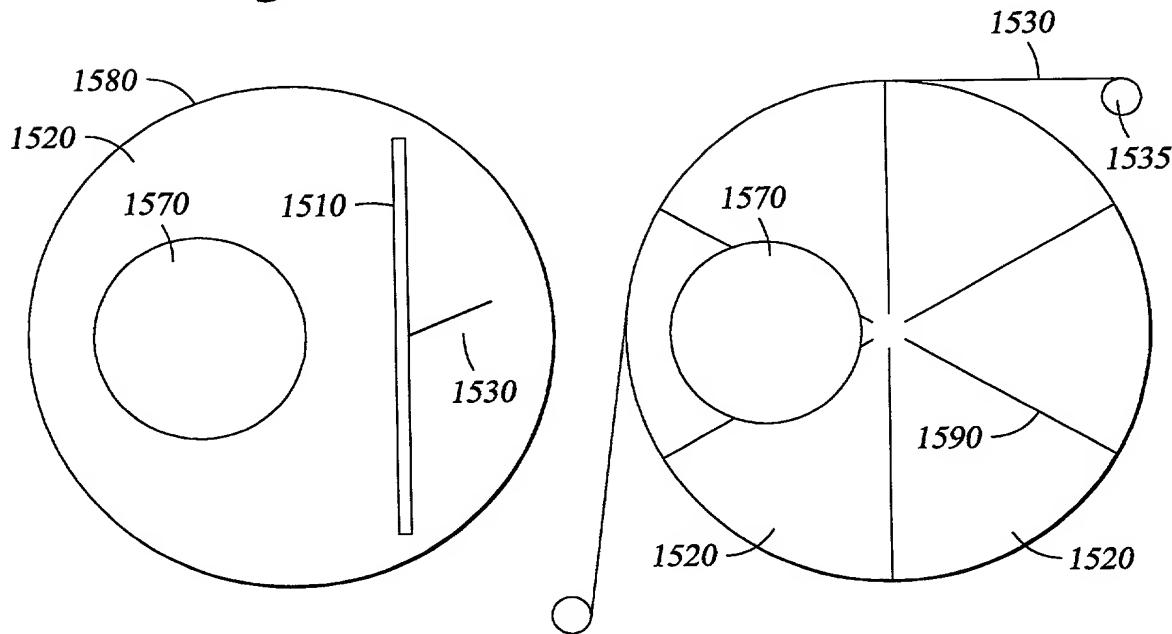


Fig. 15C

Fig. 15D